C4AQ, Radial, 2 or 4 Leads, 500 - 1,500 VDC, for DC Link (Automotive Grade)



Overview

The C4AQ capacitor is a polypropylene metallized film capacitor with a rectangular, plastic box-type design (white or grey in color) filled with resin, and uses 2 or 4 tinned copper wires.

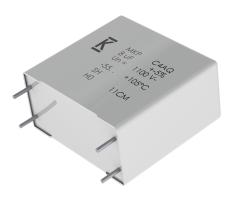
Automotive grade devices meet the demanding Automotive Electronics Council's AEC-Q200 qualification requirements.

Applications

Typical applications include DC filtering, DC link, power electronics, IGBT snubbers, energy storage, renewable energy grid interface, motor drives, and automotive applications.

Benefits

- · Self-healing
- Low loss
- · High ripple current
- · High capacitance density
- · High contact reliability
- · Suitable for high frequency applications
- Automotive Grades (AEC-Q200)

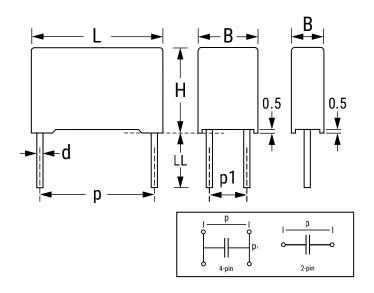


Part Number System

C4	A	Q	U	В	W	5270	A	3	N	J
Series	Туре	Application	Rated Voltage (VDC)	Case	Terminals Code	Capacitance Code (pF)	C-Spec	Lead Diameter (mm)	Size Code: B x H x L (mm)	Tolerance
C4 = MKP Power Capacitors	A = Box, wire terminals	Q = DC Link Automotive Grade	L = 500 C = 650 I = 800 Q = 1,100 U = 1,300 S = 1,500	B = Box, plastic case E = Extended box, plastic case	U = 2 pins W = 4 pins	Digits two – four indicate the first three digits of the capacitance value. First digit indicates the number of zeros to be added.	A = Standard B - Z = Special	1 = 0.8 2 = 1.0 3 = 1.2	Digit 6 = B W = 11 x 20 x 31.5 X = 13 x 25 x 31.5 Y = 14 x 28 x 31.5 1 = 19 x 29 x 31.5 E = 20 x 40 x 42 J = 28 x 37 x 42 L = 30 x 45 x 42 O = 35 x 50 x 42 M = 30 x 45 x 57.5 N = 35 x 50 x 57.5 Digit 6 = E A = 45 x 56 x 57.5 B = 45 x 65 x 57.5	J = 5% K = 10%



Dimensions - Millimeters



Size	Code		p	p 1			В		1		L	L	L		d
Digit 6	Digit 14	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance
В	W	27.5	±0.4	-	-	11.0	+0.3	20.0	+0.2	31.5	+0.5	6	+0/-2	0.8	±0.05
В	Х	27.5	±0.4	-	-	13.0	+0.3	25.0	+0.2	31.5	+0.5	6	+0/-2	0.8	±0.05
В	Υ	27.5	±0.4	-	-	14.0	+0.3	28.0	+0.2	31.5	+0.5	6	+0/-2	0.8	±0.05
В	1	27.5	±0.4	-	-	19.0	+0.3	29.0	+0.2	31.5	+0.5	6	+0/-2	0.8	±0.05
В	2	27.5	±0.4	-	-	22.0	+0.3	37.0	+0.2	31.5	+0.5	6	+0/-2	0.8	±0.05
В	F	37.5	±0.4	5.1/10.2	±0.4	20.0	+0.4	40.0	+0.2	42.0	+0.6	6	+0/-2	1.2	±0.05
В	J	37.5	±0.4	10.2	±0.4	28.0	+0.4	37.0	+0.2	42.0	+0.6	6	+0/-2	1.2	±0.05
В	L	37.5	±0.4	20.3	±0.4	30.0	+0.4	45.0	+0.2	42.0	+0.6	6	+0/-2	1.2	±0.05
В	0	37.5	±0.4	20.3	±0.4	35.0	+0.4	50.0	+0.2	42.0	+0.6	6	+0/-2	1.2	±0.05
В	М	52.5	±0.4	20.3	±0.4	30.0	+0.5	45.0	+0.3	57.5	+0.8	6	+0/-2	1.2	±0.05
В	N	52.5	±0.4	20.3	±0.4	35.0	+0.5	50.0	+0.3	57.5	+0.8	6	+0/-2	1.2	±0.05
E	Α	52.5	±0.4	20.3	±0.4	45.0	+0.5	56.0	+0.3	57.5	+0.8	6	+0/-2	1.2	±0.05
Е	В	52.5	±0.4	20.3	±0.4	45.0	+0.5	65.0	+0.3	57.5	+0.8	6	+0/-2	1.2	±0.05

Qualification

Reference Standards	IEC 61071, EN 61071, VDE0560					
Climatic Category	55/105/56 according to IEC 60068-1					

Automotive grade products meet or exceed the requirements outlined by the Automotive Electronics Council. Details regarding test methods and conditions are referenced in document AEC-Q200, Stress Test Qualification for Passive Components. For additional information regarding the Automotive Electronics Council and AEC-Q200, visit the AEC website at www.aecouncil.com.



General Technical Data

Dielectric	Polypropylene metallized film, non-inductive type, self-healing property
Application	DC filtering, DC link
Special Features	AEC-Q200 qualified
Climatic Category	55/105/56 IEC 60068-1
Maximum Operating Temperature	+105°C
	500 hours + 500 hours at 1.3 x V _{NDC} at 70°C
Endurance Test	500 hours + 500 hours at 1.3 x V _{OP85} at 85°C
	500 hours + 500 hours at 1.3 x V _{OP105} at 105°C
Standard	IEC 61071, EN 61071, VDE0560, AEC-Q200
Protection	Solvent resistant plastic case UL 94 V-0 compliant Thermosetting resin sealing UL 94 V-0 compliant
Installation	Any position
Leads	Tinned copper wires - standard lead wire length 6 (+0/-2) mm
Packaging	Packed in cardboard trays with protection for the terminals
RoHS Compliance	Compliant with Directive 2002/95/EC and Directive 2011/65/EU of the European Parliament and the Council of the EU on 8 June 2011, including the Commission Delegated Directive (EU) 2015/863 that amended Annex II to Directive 2011/65/EU.

Electrical Characteristics

Rated Capacitance Range	1 to 210 μF				
Rated Voltage (V _{NDC}) Range	500 to 1,500 VDC				
Capacitance Tolerance	±5% (J) or ±10% (K) measured at T = +25°C ±5°C				
Dissipation Factor PP Typical (tgδ0)	≤ 0.0002 at 10 kHz with T = 25°C ±5°C				
Surge Voltage	1.5 * V _{NDC} for maximum 10 times in a lifetime at 25°C ±5°C				
Overvoltage (IEC 61071)	1.15 * V _{NDC} for maximum 30 minutes, once per day				
Overvoltage (IEC 61071)	1.3 * V _{NDC} for maximum 1 minute, once per day				
Peak Non-Repetitive Current	1.5 * I _{PKR} for maximum 1,000 times in a lifetime				
Insulation Resistance	IR x C \geq 30.000 seconds at 100 VDC 1 minute at T = +25°C ±5°C				
Capacitance Deviation in Operation	±2.0% maximum on capacitance value measured at T = +25°C ±5°C				
Temperature Storage	-40 to +80°C				
Storage time	≤ 36 months from the date marked on the label glued to the package				
Permissible Relative Humidity - Storage	Annual average ≤ 70%, 85% on 30 days/year randomly distributed throughout year. Dewing not admissible.				



Life Expectancy

	100,000 hours at V_{NDC} at hot spot temperature T_{HS} = +70°C
Life Expectancy	100,000 hours at V_{OP85} at hot spot temperature T_{HS} = +85°C
	10,000 hours at V_{OP105} at hot spot temperature T_{HS} = +105°C
Capacitance Drop at End of Life	-5% (typical)
Failure Pata IFC 61700	\leq 300 FIT at V _{OP85} at hot spot temperature T _{HS} = +85°C
Failure Rate IEC 61709	≤ 200 FIT at V _{NDC} at hot spot temperature T _{HS} = +70°C

Test Method

Test Voltage Between Terminals	$1.5 * V_{NDC}$ for 10 seconds or $1.65 * V_{NDC}$ for 2 seconds, at T = $+25 ° C \pm 5 ° C$				
Test Voltage Between Terminals and Case	3.2 k VAC 50 Hz for 2 seconds				
Damp Heat	IEC 60068-2-78				
Change of Temperature	IEC 60068-2-14				
Biased Humidity Test 40°C/93% R.H. at V _{NDC} - 1,000 hours	$ \Delta C/C_0 \le 5\%$ $ \Delta DF/DF_0 \le 200\%$ (at 10 kHz) $IR \ge 50\%$ of initial limit				
Biased Humidity Test 60°C/95% R.H. at V _{NDC} - 1,000 hours	$ \Delta C/C_0 \le 5\%$ $ \Delta DF/DF_0 \le 200\%$ (at 10 kHz) IR ≥ 100 MΩ				

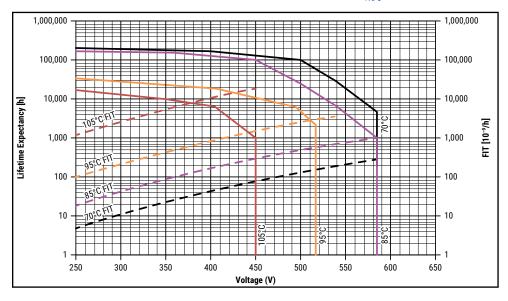
Operative Voltage Derating

	Symbol		Voltage (VDC)						
Rated Voltage at 70°C (T _{HS})	V _{NDC}	500	650	800	1,100	1,300	1,500	100,000	
Operating Voltage at 85°C (T _{HS})	V _{OP85}	450	600	700	900	1,100	1,200	100,000	
Operating Voltage at 105°C (T _{HS})	V _{0P105}	350	450	550	700	850	900	10,000	

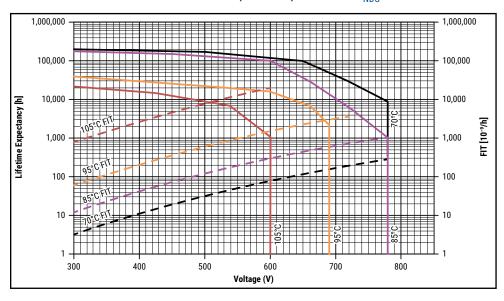


Life Expectancy/Failure Quota Graphs

Lifetime Curve & FIT at Hot Spot Temperature - V_{NDC} = 500 VDC



Lifetime Curve & FIT at Hot Spot Temperature - V_{NDC} = 650 VDC



Notes:

 $T_{HS} = T_{AMB} + \Delta T$

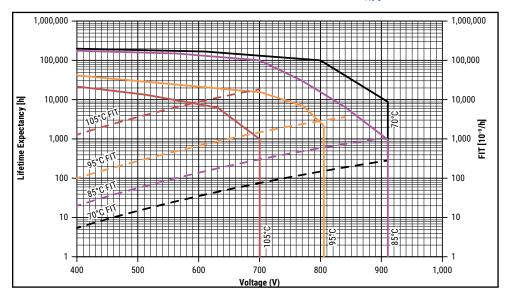
 $\Delta T = ESR * I_{rms}^2 * Rth$

 I_{rms} should be limited to values granting $\Delta T \le 30$ °C

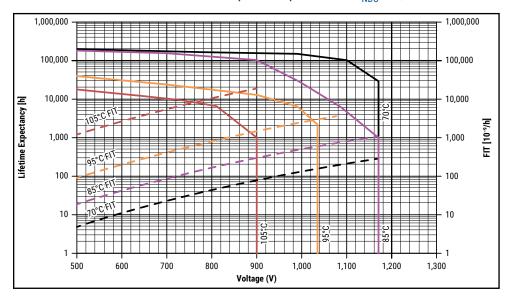


Life Expectancy/Failure Quota Graphs cont'd.

Lifetime Curve & FIT at Hot Spot Temperature - V_{NDC} = 800 VDC



Lifetime Curve & FIT at Hot Spot Temperature - V_{NDC} = 1,100 VDC



Notes:

 $T_{HS} = T_{AMB} + \Delta T$

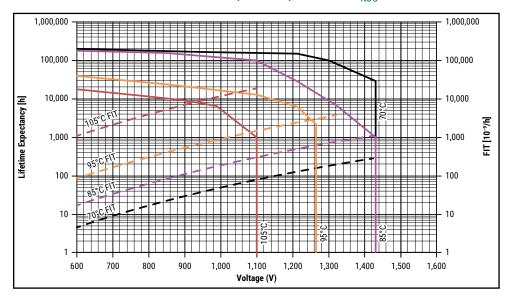
 $\Delta T = ESR * I_{rms}^2 * Rth$

 I_{rms} should be limited to values granting $\Delta T \le 30$ °C

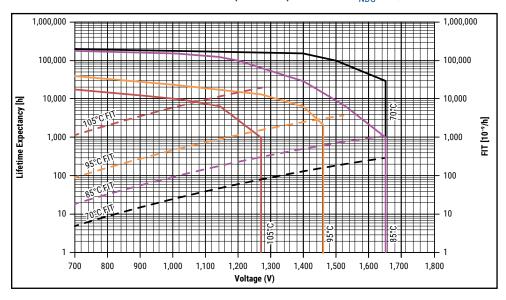


Life Expectancy/Failure Quota Graphs cont'd.

Lifetime Curve & FIT at Hot Spot Temperature - V_{NDC} = 1,300 VDC



Lifetime Curve & FIT at Hot Spot Temperature - V_{NDC} = 1,500 VDC



Notes:

 $T_{HS} = T_{AMB} + \Delta T$

 $\Delta T = ESR * I_{rms}^2 * Rth$

 I_{rms} should be limited to values granting $\Delta T \le 30$ °C



Environmental Compliance

As a leading global supplier of electronic components and an environmentally conscious company, KEMET continually aspires to improve the environmental effects of our manufacturing processes and our finished electronic components.

In Europe (RoHS Directive) and in some other geographical areas such as China (China RoHS), legislation has been enacted to prevent or otherwise limit the use of certain hazardous materials, including lead (Pb), in electronic equipment. KEMET monitors legislation globally to ensure compliance and endeavors to adjust our manufacturing processes and/or electronic components as may be required by applicable law.

For military, medical, automotive, and some commercial applications, the use of lead (Pb) in the termination is necessary and/or required by design. KEMET is committed to communicating RoHS compliance to our customers. Information related to RoHS compliance will be provided in data sheets and using specific identifiers on the packaging labels.

All KEMET power film capacitors are RoHS compliant.

Materials & Environment

The selection of raw materials that KEMET uses for the production of its electronic components is the result of extensive experience. KEMET directs specific attention toward environmental protection. KEMET selects its suppliers according to ISO 9001 standards and performs statistical analyses on raw materials before acceptance for use in manufacturing our electronic components. All materials are, to the best of KEMET's knowledge, non-toxic and free from cadmium; mercury; chrome and compounds; polychlorine triphenyl (PCB); bromide and chlorinedioxins bromurate clorurate; CFC and HCFC; and asbestos.

Dissipation Factor

Dissipation factor is a complex function involved with capacitor inefficiency. The tgδ may vary up and down with increased temperature. For more information, refer to Performance Characteristics.

Sealing

Hermetically Sealed Capacitors

As the temperature increases, the pressure inside the capacitor increases. If the internal pressure is high enough, it can cause a breach in the capacitor. Such a breach can result in leakage, impregnation, filling fluid, or moisture susceptibility.

Barometric Pressure

The altitude at which hermetically sealed capacitors are operated controls the capacitor's voltage rating. As the barometric pressure decreases, the susceptibility to terminal arc-over increases. Non-hermetic capacitors can be affected by internal stresses due to pressure changes. These effects can be in the form of capacitance changes, dielectric arc-over, and/or low insulation resistance. Altitude can also affect heat transfer. Heat that is generated in an operation cannot be dissipated properly, and high RI2 losses and eventual failure can result.



Table 1 - Ratings & Part Number Reference

Value (µF)	VDC		Dime	nsions	(mm)		dV/dt	lpkr	ESL	ESR 70°C at 10 kHz	Irms* 70°C at 10 kHz	Rth (HS/Amb)	Packaging Quantity	PART NUMBER
Cap		В	Н	L	P	P1	V/µs	Apk	nH	mΩ	Arms	(°C/W)		
100 ¹	800	45	65	57.5	52.5	20.3	9	883	45	1.9	30.5	7	18	C4AQIEW6100A3BJ
85 ¹	800	45	56	57.5	52.5	20.3	9	728	41	2.5	25.5	8	18	C4AQIEW5850A3AJ
60	800	35	50	57.5	52.5	20.3	9	530	35	3.6	19.5	10	23	C4AQIBW5600A3NJ
45 55	800 800	30 35	45 50	57.5 57.5	52.5	20.3	9	389 485	35	4.4 3.6	16 19	12	27	C4AQIBW5450A3MJ C4AQIBW5550A3NJ
					37.5 52.5	20.3	13 9	524	35	2.2	21.5	13 12	30 27	C4AQIBW5400A30J
30 40	800 800	30 35	45 50	42 42	37.5	20.3	13	389	30 35	3.2	16.5	15	36 30	C4AQIBW5300A3LJ
20	800	28	37	42	37.5	10.2	13	262	30	4.7	12.5	18	36	C4AQIBW5200A3JJ
15	800	20	40	42	37.5	10.2	13	196	30	6.2	10	20	58	C4AQIBW5150B3FJ
15	800	20	40	42	37.5	5.1	13	196	30	6.2	10	20	58	C4AQIBW5150A3FJ
12.5	800	22	37	31.5	27.5	\	19	241	28	5.5	10	23	64	C4AQIBU5125A12J
8	800	19	29	31.5	27.5	\	19	154	26	7.3	8	29	72	C4AQIBU4800A11J
5	800	14	28	31.5	27.5	\	19	96	26	10.7	6	33	96	C4AQIBU4500A1YJ
4	800	13	25	31.5	27.5	\	19	77	25	12.9	5.5	36	234	C4AQIBU4400A1XJ
2.7	800	11	20	31.5	27.5	\	19	51	25	18.3	4	44	256	C4AQIBU4270A1WJ
0.7	000	11	00	01.5	07.5						at 105°C = 550 V		054	0440101140704414
190 .	030	40	UO	37.3	52.5								10	U4AQUEW013UA3BJ
110 ¹	650	45 45	65	57.5	52.5	20.3	6	754	41	2.2 1.7	32	8 7	18	C4AQCEW6130A3BJ
75 110 ¹	650 650	35 45	50 56	57.5 57.5	52.5 52.5	20.3 20.3	6 6	435 625	35 41	3.1 2.2	20.5 27	10 8	23 18	C4AQCBW5750A3NJ C4AQCEW6110A3AJ
55 75	650	30	45	57.5	52.5	20.3	•	319	35	4.1	16.5	12	=:	C4AQCBW5550A3MJ
50	650	35	50	42	37.5	20.3	9 6	430	35	2	22.5	13	30 27	C4AQCBW5500A30J
40	650	30	45	42	37.5	20.3	9	344	30	2.8	18	15	36	C4AQCBW5400A3LJ
30	650	28	37	42	37.5	10.2	9	255	30	3.6	14	18	36	C4AQCBW5300A3JJ
20	650	20	40	42	37.5	10.2	9	172	30	5.3	11	20	58	C4AQCBW5200A3FJ
15	650	22	37	31.5	27.5	10.0	13	190	28	5.3	10.5	23	64	C4AQCBU5150A12J
10	650	19	29	31.5	27.5	\	13	127	26	6.8	8.5	29	72	C4AQCBU5100A11J
7	650	14	28	31.5	27.5	\	13	88	26	9	7	33	96	C4AQCBU4700A1YJ
5.6	650	13	25	31.5	27.5	\	13	71	25	10.7	6	36	234	C4AQCBU4560A1XJ
3.3	650	11	20	31.5	27.5	,	13	41	25	17	4	44	256	C4AQCBU4330A1WJ
0.0	V _{NDC} at 70°C = 650 VDC; V _{OP85} at 85°C = 600 VDC; V _{OP105} at 105°C = 450 VDC													
210 '	500	45	00	57.5	52.5								10	C4AQLEW0ZIUA3BK
210 ¹	500	45 45	65	57.5	52.5	20.3	4 4	780 840	41	1.8	29.5 35.5	8 7	18 18	C4AQLEW6210A3BK
170 ¹	500	45	56	57.5	52.5	20.3	4	780	41	1.8	23	8	23 18	C4AQLEW6170A3AK
130	500	35	50	57.5	52.5	20.3	4	581	35	2.4	23	12	27	C4AQLBW6130A3NK
90 100	500	35	45	57.5	37.5 52.5	20.3	4	585 442	35	3	26 19	13 12	30 27	C4AQLBW5900A30K C4AQLBW6100A3MK
70 90	500	30 35	45 50	42 42	37.5	20.3	7	464 585	30	1.5	20.5	15 13	36 30	C4AQLBW5700A3LK
70	500	28 30	45	42	37.5	20.3	7	332 464	30	2.8	20.5	18 15	36 36	-
40 50	500	20 28	37	42	37.5 37.5	10.2	7	332	30	2.8	16	20 18	36	C4AQLBW5500A3JK
25 40	500 500	22	37 40	31.5 42	27.5 37.5	10.2	10 7	245 262	28 30	4.5 3.5	11.5 13.5	23 20	64 58	C4AQLBU5250A12K C4AQLBW5400A3FK
		19 22			-	\	-		-					•
12.5	500	14 19	28	31.5	27.5	\	10 10	122	26	6.8	7.5 8.5	33 29	96 72	C4AQLBU5125A1YK C4AQLBU5150A11K
12.5	500	14	25 28	31.5	27.5	\	10	96 122	25 26	6.8	7.5	33	234 96	C4AQLBU5100A1XK
5.6 10	500 500	11 13	20	31.5 31.5	27.5 27.5	\	10 10	54 96	25 25	13.1 8.1	4.5 6.5	44 36	256 234	C4AQLBU4560A1WK
Г.(T 500	11	00	01.5	07.5	v _{NDC} a	=				at 105°C = 350 V		056	04401 01145(044141)
					_		•	•						
(F.)		В	Н	L	Р	P1	V/µs	Apk	nH	mΩ	Arms	(°C/W)		
(µF)											11.12		Quantity	NUMBER
Value	VDC			(111111)						kHz	kHz	(ITS/AIIID)	Quantity	NUMBER
	VDO			(mm)			dV/dt	lpkr	ESL		70°C at 10	(HS/Amb)	Packaging	PART
Cap			Din	nensi	ons		JWG	Lasten	FOL	_	_	Rth	_	
										ESR	Irms*			

¹ Items available for sample.

^(*) I_{rms} value that leads to a ΔT of $\approx 15^{\circ}C$ in the hot spot > $T_{HS} = T_{AMB} + \Delta T = 70^{\circ}C + 15^{\circ}C = 85^{\circ}C$



Table 1 - Ratings & Part Number Reference cont'd.

Cap Value (µF)	VDC			nensi (mm)			dV/dt	lpkr	ESL	ESR 70°C at 10 kHz	Irms* 70°C at 10 kHz	Rth (HS/Amb)	Packaging Quantity	PART NUMBER
(рі)		В	Н	L	Р	P1	V/µs	Apk	nH	mΩ	Arms	(°C/W)		
						V _{NDC} at	70°C = 1,1	00 VDC; Va	_{1P85} at 85°C	= 900 VDC; V _{OP10}	₅ at 105°C = 700	VDC		
1.5	1100	11	20	31.5	27.5	\	24	36	25	26.3	3.5	44	256	C4AQQBU4150A1WJ
2.7	1100	13	25	31.5	27.5	\	24	65	25	15.3	5	36	234	C4AQQBU4270A1XJ
3.3	1100	14	28	31.5	27.5	\	24	79	26	12.9	5.5	33	96	C4AQQBU4330A1YJ
5	1100	19	29	31.5	27.5	١	24	120	26	9.1	7	29	72	C4AQQBU4500A11J
8	1100	22	37	31.5	27.5	١	24	193	28	6.6	9.5	23	64	C4AQQBU4800A12J
12	1100	20	40	42	37.5	10.2	16	190	30	6.3	10	20	58	C4AQQBW5120A3FJ
14	1100	28	37	42	37.5	10.2	16	229	30	5.4	11.5	18	36	C4AQQBW5140A3JJ
20	1100	30	45	42	37.5	20.3	16	321	30	3.9	15	15	36	C4AQQBW5200A3LJ
25	1100	35	50	42	37.5	20.3	16	409	35	2.8	19	13	30	C4AQQBW5250A30J
30	1100	30	45	57.5	52.5	20.3	11	324	35	5.2	15	12	27	C4AQQBW5300A3MJ
40	1100	35	50	57.5	52.5	20.3	11	428	35	4	18	10	23	C4AQQBW5400A3NJ
55 ¹	1100	45	56	57.5	52.5	20.3	11	595	41	2.6	24.5	8	18	C4AQQEW5550A3AJ
65 ¹	1100	45	65	57.5	52.5	20.3	11	717	45	2.3	28	7	18	C4AQQEW5650A3BJ
V _{NDC} at 70°C = 1,300 VDC; V _{OP85} at 85°C = 1,100 VDC; V _{OP105} at 105°C = 850 VDC														
1	1300	11	20	31.5	27.5	\	28	28	25	33.1	3	44	256	C4AQUBU4100A1WJ
1.8	1300	13	25	31.5	27.5	\	29	52	25	19.1	4.5	36	234	C4AQUBU4180A1XJ
2.2	1300	14	28	31.5	27.5	\	29	63	26	16	5	33	96	C4AQUBU4220A1YJ
3.3	1300	19	29	31.5	27.5	\	29	95	26	11.2	6.5	29	72	C4AQUBU4330A11J
5	1300	22	37	31.5	27.5	\	29	145	28	8.2	8.5	23	64	C4AQUBU4500A12J
8	1300	20	40	42	37.5	10.2	20	157	30	7.9	9	20	58	C4AQUBW4800A3FJ
10	1300	28	37	42	37.5	10.2	20	196	30	6.3	11	18	36	C4AQUBW5100A3JJ
12	1300	30	45	42	37.5	20.3	20	235	30	5.3	13	15	36	C4AQUBW5120A3LJ
18	1300	35	50	42	37.5	20.3	19	350	35	3.2	18	13	30	C4AQUBW5180A30J
20	1300	30	45	57.5	52.5	20.3	13	262	35	6.5	13	12	27	C4AQUBW5200A3MJ
25	1300	35	50	57.5	52.5	20.3	13	331	35	5.2	16	10	23	C4AQUBW5250A3NJ
27	1300	35	50	57.5	52.5	20.3	13	354	35	4.9	16.5	10	23	C4AQUBW5270A3NJ
38 ¹	1300	45	56	57.5	52.5	20.3	13	498	41	3.1	22.5	8	18	C4AQUEW5380A3AJ
45 ¹	1300	45	65	57.5	52.5	20.3	13	596	45	2.7	26	7	18	C4AQUEW5450A3BJ
											₁₀₅ at 105°C = 900			
1.0	1500	11	20	31.5	27.5	\	31	31	24	25.7	3.5	44	256	C4AQSBU4100A1WJ
1.5	1500	13	25	31.5	27.5	\	31	49	25	17.7	4.5	36	234	C4AQSBU4150A1XJ
2.0	1500	14	28	31.5	27.5	\	32	65	26	14.1	5.5	33	96	C4AQSBU4200A1YJ
3.0	1500	19	29	31.5	27.5	\	32	95	26	9.7	7	29	72	C4AQSBU4300A11J
4.5	1500	22	37	31.5	27.5	10.0	33	148	28	7.3	9	23	64	C4AQSBU4450A12J
6.0	1500	20	40	42	37.5	10.2	22	132	30	8	9	20	58	C4AQSBW4600A3FJ
8.0	1500	28	37	42	37.5	10.2	22	176	30	6	11	18	36	C4AQSBW4800A3JJ
12	1500	30	45	42	37.5	20.3	22	256	33	4.1	14.5	15	36	C4AQSBW5120A3LJ
15	1500	35	50	42	37.5	20.3	22	326	35	3.5	17.5	13	30	C4AQSBW5150A30J
17	1500	30	45	57.5	52.5	20.3	14	236	35	5.9	13.5	12	27	C4AQSBW5170A3MJ
22	1500	35	50	57.5	52.5	20.3	14	308	38	4.6	17	10	23	C4AQSBW5220A3NJ
32 ¹	1500	45	56	57.5	52.5	20.3	14	460	41	3.4	22	8	18	C4AQSEW5320A3AJ
40 1	1500	45	65	57.5	52.5	20.3	14	562	45	2.8	25	7	18	C4AQSEW5400A3BJ
Can		В	Н	L	P	P1	V/µs	Apk	nH	mΩ	Arms	(°C/W)		
Cap Value (µF)	VDC		Dime	nsions	(mm)		dV/dt	lpkr	ESL	ESR 70°C at 10 kHz	Irms* 70°C at 10 kHz	Rth (HS/Amb)	Packaging Quantity	PART NUMBER

¹ Items available for sample.

^(*) I_{rms} value that leads to a ΔT of $\approx 15^{\circ}C$ in the hot spot > $T_{HS} = T_{AMB} + \Delta T = 70^{\circ}C + 15^{\circ}C = 85^{\circ}C$



Soldering Process

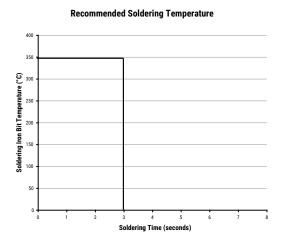
The implementation of the RoHS directive has resulted in the selection of SnAuCu (SAC) alloys, or SnCu alloys, as the primary solder material. This has increased the liquidus temperature from 183° C for a SnPb eutectic alloy to $217 - 221^{\circ}$ C for new alloys. As a result, the heat stress to the components, even in wave soldering, has increased considerably due to higher pre-heat and wave temperatures. Polypropylene capacitors are especially sensitive to heat (the melting point of polypropylene is $160 - 170^{\circ}$ C). Wave soldering can be destructive, especially for mechanically small polypropylene capacitors (with lead spacing of 5 - 15 mm), and great care must be taken during soldering. The recommended solder profiles from KEMET should be used. Contact KEMET with any questions. In general, the wave soldering curve from IEC Publication 61760-1 Edition 2 serves as a solid guideline for successful soldering. See Figure 1.

Reflow soldering is not recommended for through-hole film capacitors. Exposing capacitors to a soldering profile in excess of the recommended limits may result in degradation or permanent damage to the capacitors.

Do not place the polypropylene capacitor through an adhesive curing oven to cure resin for surface mount components. Insert through-hole parts after curing the surface mount parts. Contact KEMET to discuss the actual temperature profile in the oven, if through-hole components must pass through the adhesive curing process. A maximum two soldering cycles is recommended. Allow time for the capacitor surface temperature to return to normal before the second soldering cycle.

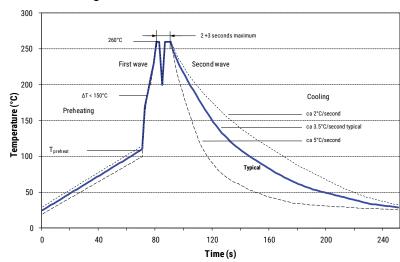
Manual Soldering Recommendations

Following is the recommendation for manual soldering with a soldering iron.



The soldering iron tip temperature should be set at 350°C (+10°C maximum) with the soldering duration not to exceed more than 3 seconds.

Wave Soldering Recommendations





Soldering Process cont'd

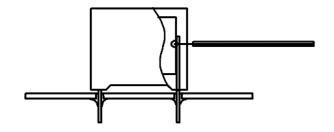
Wave Soldering Recommendations cont'd

1. The tables indicates the maximum set-up temperature of the soldering process

Dielectric		imum Pre emperatu	Maximum Peak Soldering Temperature		
Film Material	Capacitor Pitch ≤ 10 mm	Capacitor Pitch = 15 mm	Capacitor Pitch > 15 mm	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm
Polyester	130°C	130°C	130°C	270°C	270°C
Polypropylene	100°C	110°C	130°C	260°C	270°C
Paper	130°C	130°C	140°C	270°C	270°C
Polyphenylene Sulphide	150°C	150°C	160°C	270°C	270°C

2. The maximum temperature measured inside the capacitor: set the temperature so that inside the element the maximum temperature is below the limit.

Dielectric Film Material	Maximum Temperature Measured Inside the Element				
Polyester	160°C				
Polypropylene	110°C				
Paper	160°C				
Polyphenylene Sulphide	160°C				



Temperature monitored inside the capacitor.

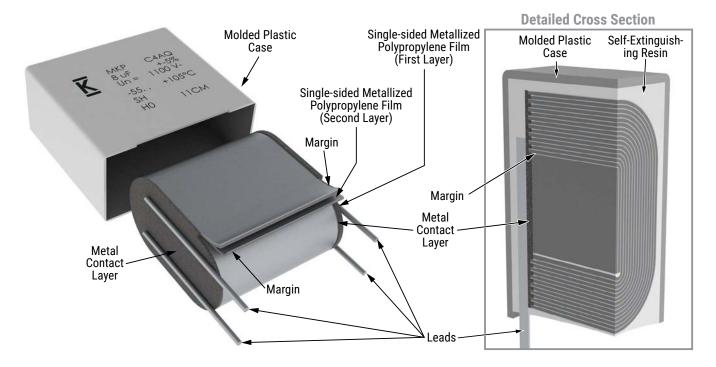
Selective Soldering Recommendations

Selective dip soldering is a variation of reflow soldering. In this method, the printed circuit board with through-hole components to be soldered is pre-heated and transported over the solder bath, as in normal flow soldering, without touching the solder. When the board is over the bath, it is stopped. Pre-designed solder pots are lifted from the bath with molten solder, only at the places of the selected components, and pressed against the lower surface of the board to solder the components.

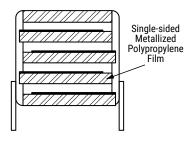
The temperature profile for selective soldering is similar to the double wave flow soldering outlined in this document. However, instead of two baths, there is only one with a time from 3 – 10 seconds. In selective soldering, the risk of overheating is greater than in double wave flow soldering, and great care must be taken so that the parts do not overheat.



Construction

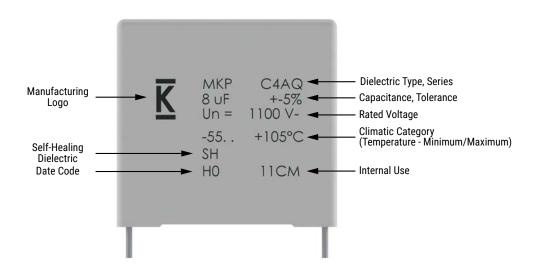


Winding Scheme





Marking



Manufacturing Date Code (IEC-60062)			
Y = Year, Z = Month			
Year	Code	Month	Code
2010	Α	January	1
2011	В	February	2
2012	С	March	3
2013	D	April	4
2014	E	May	5
2015	F	June	6
2016	Н	July	7
2017	J	August	8
2018	K	September	9
2019	L	October	0
2020	М	November	N
2021	N	December	D
2022	Р		
2023	R		
2024	S		
2025	Т		
2026	U		
2027	V		
2028	W		
2029	X		
2030	Α		



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